Preferred Device

# One Watt Amplifier Transistor

## **PNP Silicon**

### Features

• Pb-Free Package is Available\*

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	-80	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	-80	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	-4.0	Vdc
Collector Current – Continuous	Ι <sub>C</sub>	-500	mAdc
Total Device Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	PD	1.0 8.0	W mW/°C
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	2.5 20	W mW/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

### THERMAL CHARACTERISTICS

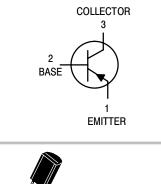
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	125	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	50	°C/W

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



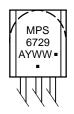
## **ON Semiconductor®**

http://onsemi.com





## MARKING DIAGRAM



MPS6729 = Device Code

= Assembly Location

= Year

A Y

WW

- = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)

### **ORDERING INFORMATION**

Device	Package	Shipping
MPS6729	TO-92	5000 Units / Bulk
MPS6729G	TO–92 (Pb–Free)	5000 Units / Bulk

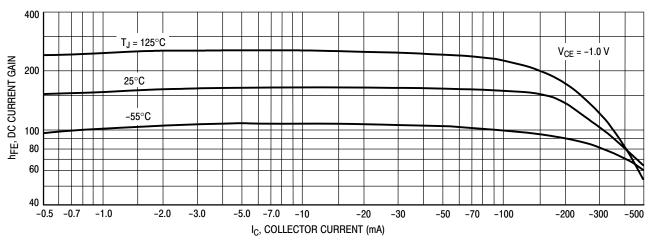
\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

Preferred devices are recommended choices for future use and best overall value.

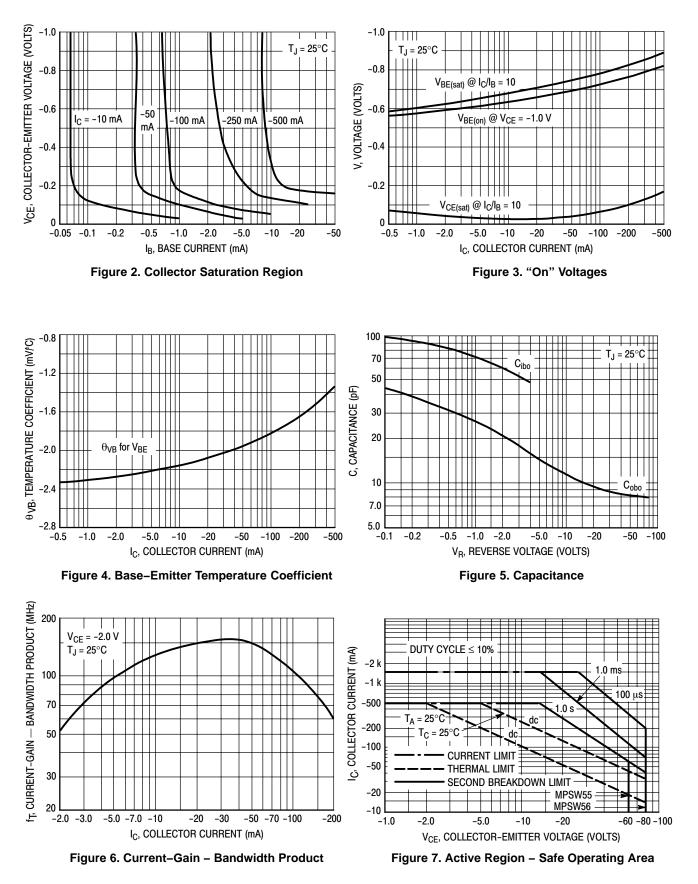
## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = $25^{\circ}$ C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				•
Collector – Emitter Breakdown Voltage (Note 1) $(I_C = -1.0 \text{ mAdc}, I_B = 0)$	V <sub>(BR)CEO</sub>	-80	-	Vdc
Collector – Base Breakdown Voltage ( $I_C = 0.1 \text{ mA}, I_E = 0$ )	V <sub>(BR)CBO</sub>	-80	-	Vdc
Emitter – Base Breakdown Voltage $(I_E = -10 \ \mu Adc, I_C = 0)$	V <sub>(BR)EBO</sub>	-5.0	-	Vdc
Collector Cutoff Current ( $V_{CB} = -60 \text{ Vdc}, I_E = 0$ )	I <sub>CBO</sub>	-	-0.1	μAdc
Emitter Cutoff Current ( $V_{EB} = -5.0 \text{ Vdc}, I_C = 0$ )	I <sub>EBO</sub>	-	-10	μAdc
ON CHARACTERISTICS (Note 1)				
DC Current Gain ( $I_C = -50 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc}$ ) ( $I_C = -250 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc}$ )	h <sub>FE</sub>	80 50	250	-
Collector – Emitter Saturation Voltage ( $I_C = -250 \text{ mAdc}$ , $I_B = -10 \text{ mAdc}$ )	V <sub>CE(sat)</sub>	-	-0.5	Vdc
Base-Emitter On Voltage ( $I_C = -250 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc}$ )	V <sub>BE(on)</sub>	-	-1.2	Vdc
SMALL-SIGNAL CHARACTERISTICS				•
Collector–Base Capacitance (V <sub>CB</sub> = -10 Vdc, f = 1.0 MHz)	C <sub>cb</sub>	-	30	pF
Small–Signal Current Gain (I <sub>C</sub> = 200 mA, $V_{CE}$ = 5.0 V, f = 20 MHz)	h <sub>fe</sub>	2.5	25	

1. Pulse Test: Pulse Width  $\leq$  300 µs, Duty Cycle  $\leq$  2.0%.

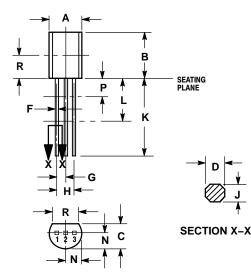






#### PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-10 ISSUE AL



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

- 2. CONTROLLING DIMENSION: INCH.
- 3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
- L. DIMENSION F APPLIES BETWEEN P AND L DIMENSIONS D AND J APPLY BETWEEN L AND K MIMMUM. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIN	IMETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.175	0.205	4.44	5.21	
В	0.290	0.310	7.37	7.87	
С	0.125	0.165	3.18	4.19	
D	0.018	0.021	0.457	0.533	
F	0.016	0.019	0.407	0.482	
G	0.045	0.055	1.15	1.39	
Н	0.095	0.105	2.42	2.66	
ſ	0.018	0.024	0.46	0.61	
Κ	0.500		12.70		
L	0.250		6.35		
Ν	0.080	0.105	2.04	2.66	
Ρ		0.100		2.54	
R	0.135		3.43		

STYLE 1: PIN 1. EMITTER

2. BASE

3. COLLECTOR

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